1.8V / 2.5V, 10GHz ÷4 Clock Divider with CML Outputs

Multi-Level Inputs w/ Internal Termination

Description

The NB7V33M is a differential $\div 4$ Clock divider with asynchronous reset. The differential Clock inputs incorporate internal 50 Ω termination resistors and will accept LVPECL, CML and LVDS logic levels. The NB7V33M produces a $\div 4$ output copy of an input Clock operating up to 10 GHz with minimal jitter. The Reset pin is asserted on the rising edge. Upon powerup, the internal flip – flops will attain a random state; the Reset allows for the synchronization of multiple NB7V33M's in a system. The 16 mA differential CML output provides matching internal 50 Ω termination which guarantees 400 mV output swing when externally receiver terminated with 50 Ω to V_{CC}.

The NB7V33M is the $\div 4$ version of the NB7V32M ($\div 2$) and is offered in a low profile 3 mm x 3 mm 16-pin QFN package.

The NB7V33M is a member of the GigaComm[™] family of high performance clock products. Application notes, models, and support documentation are available at www.onsemi.com.

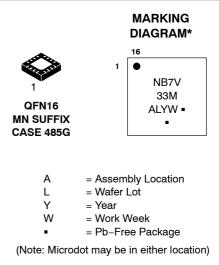
Features

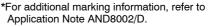
- Maximum Input Clock Frequency > 10 GHz, typical
- 260 ps Typical Propagation Delay
- 35 ps Typical Rise and Fall Times
- Differential CML Outputs, 400 mV Peak-to-Peak, Typical
- Operating Range: $V_{CC} = 1.71$ V to 2.625 V with GND = 0 V
- Internal 50 Ω Input Termination Resistors
- Random Clock Jitter < 0.8 ps RMS
- QFN-16 Package, 3 mm x 3 mm
- -40°C to +85°C Ambient Operating Temperature
- These are Pb-Free Devices



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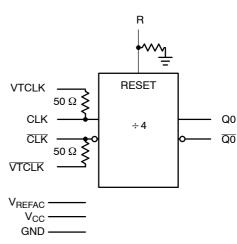


Figure 1. Simplified Logic Diagram

ORDERING INFORMATION

See detailed ordering and shipping information in the package dimensions section on page 9 of this data sheet.

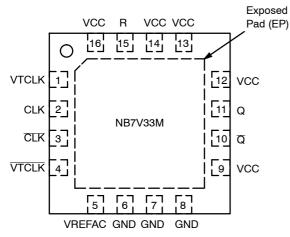


Figure 2. Pin Configuration (Top View)

Table 2. PIN DESCRIPTION

Table 1. TRUTH TABLE

CLK	CLK	R	Q	Q
х	x	Н	L	Н
Z	W	L	CLK ÷ 4	CLK ÷ 4

Z = Low to High Transition

W = High to Low Transition

X = Don't Care

Pin	Name	I/O	Description
1	VTCLK	_	Internal 50 Ω Termination Pin for CLK
2	CLK	LVPECL, CML, LVDS Input	Non-inverted Differential CLK Input. Note 1.
3	CLK	LVPECL, CML, LVDS Input	Inverted Differential CLK Input. Note 1.
4	VTCLK	-	Internal 50 Ω Termination Pin for $\overline{\text{CLK}}$
5	VREFAC	-	Internally Generated Output Voltage Reference for Capacitor-Coupled Inputs, Only
6	GND	-	Negative Supply Voltage
7	GND	-	Negative Supply Voltage
8	GND	-	Negative Supply Voltage
9	Vcc	-	Positive Supply Voltage. Note 2.
10	Q	CML Output	Inverted Differential Output
11	Q	CML Output	Non-Inverted Differential Output
12	Vcc	-	Positive Supply Voltage. Note 2.
13	Vcc	-	Positive Supply Voltage. Note 2.
14	Vcc	-	Positive Supply Voltage. Note 2.
15	R	LVCMOS Input	Asynchronous Reset Input. Internal 75 k Ω pulldown to GND.
16	Vcc	-	Positive Supply Voltage. Note 2.
-	EP	-	The Exposed Pad (EP) on the QFN–16 package bottom is thermally connected to the die for improved heat transfer out of package. The exposed pad must be attached to a heat–sinking conduit. The pad is electrically connected to the die, and must be electrically and thermally con- nected to GND on the PC board.

 In the differential configuration when the input termination pins (VTCLK/VTCLK) are connected to a common termination voltage or left open, and if no signal is applied on CLK/CLK input, then the device will be susceptible to self-oscillation. Q/Q outputs have internal 50 Ω source termination resistors.

2. All V_{CC} and GND pins must be externally connected to a power supply for proper operation.

Table 3. ATTRIBUTES

Characteristic	Value			
ESD Protection Human Body Model Machine Model		> 4 kV > 200 V		
R _{PD} – Reset Input Pulldown Resistor	75 kΩ			
Moisture Sensitivity (Note 3)	Level 1			
Flammability Rating	UL 94 V-0 @ 0.125 in			
Transistor Count	190			
Meets or exceeds JEDEC Spec EIA/JESD78 IC Latchup Test				

3. For additional information, see Application Note AND8003/D.

Table 4. MAXIMUM RATINGS

Symbol	Parameter	Condition 1	Condition 2	Rating	Unit
V _{CC}	Positive Power Supply	GND = 0 V		3.0	V
V _{IN}	Positive Input Voltage	GND = 0 V		–0.5 to V _{CC} +0.5	V
V _{INPP}	Differential Input Voltage D - D			1.89	V
I _{IN}	Input Current Through R_T (50 Ω Resistor)			±40	mA
I _{OUT}	Output Current Through R_T (50 Ω Resistor)			±40	mA
IVFREFAC	VREFAC Sink/Source Current			±1.5	mA
T _A	Operating Temperature Range			-40 to +85	°C
T _{stg}	Storage Temperature Range			-65 to +150	°C
θ_{JA}	Thermal Resistance (Junction-to-Ambient) (Note 4)	0 lfpm 500 lfpm	QFN-16 QFN-16	42 35	°C/W
θ^{JC}	Thermal Resistance (Junction-to-Case) (Note 4)		QFN-16	4	°C/W
T _{sol}	Wave Solder Pb-Free			265	°C

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

4. JEDEC standard multilayer board - 2S2P (2 signal, 2 power) with 8 filled thermal vias under exposed pad.

Symbol	Characteristic	Min	Тур	Max	Unit
POWER	SUPPLY CURRENT	·			
I _{CC}		.5 V ± 5% .8 V ± 5%	95 85	115 100	mA
CML OU	TPUTS	I			
V _{OH}		$\begin{array}{c} C = 2.5 \text{ V} \\ C = 1.8 \text{ V} \end{array} \qquad \begin{array}{c} V_{CC} - 30 \\ 2470 \\ 1770 \end{array}$	V _{CC} – 10 2490 1790	V _{CC} 2500 1800	mV
V _{OL}		$C = 2.5 V$ $V_{CC} - 650$ 1850 $V_{CC} - 600$ 1200	$\begin{matrix} V_{CC} - 550 \\ 1950 \\ V_{CC} - 500 \\ 1300 \end{matrix}$	$\begin{matrix} V_{CC} - 450 \\ 2050 \\ V_{CC} - 400 \\ 1400 \end{matrix}$	mV
DIFFERE	NTIAL INPUTS DRIVEN SINGLE-ENDED (Note 7) (Figures 5	& 6)			
V _{th}	Input Threshold Reference Voltage Range (Note 8)	1050		V _{CC} – 100	mV
V _{IH}	Single-ended Input HIGH Voltage	V _{th} + 100		V _{CC}	mV
V _{IL}	Single-ended Input LOW Voltage	GND		V _{th} – 100	mV
V _{ISE}	Single-ended Input Voltage (V _{IH} - V _{IL})			1200	mV
VREFAC					
V _{REFAC}		$\begin{array}{c c} \text{pputs, Only} \\ \text{C} = 2.5 \text{ V} \\ \text{C} = 1.8 \text{ V} \end{array} \begin{array}{c} \text{V}_{\text{CC}} - 850 \\ \text{V}_{\text{CC}} - 750 \end{array}$		$\begin{array}{c} V_{CC}-500\\ V_{CC}-450 \end{array}$	mV
DIFFERE	ENTIAL INPUTS DRIVEN DIFFERENTIALLY (Figures 7 & 8) (N	ote 9)			
V _{IHD}	Differential Input HIGH Voltage	1100		V _{CC}	mV
V _{ILD}	Differential Input LOW Voltage	GND		V _{CC} – 100	mV
V _{ID}	Differential Input Voltage (V _{IHD} – V _{ILD})	100		1200	mV
V _{CMR}	Input Common Mode Range (Differential Configuration, Note ure 9)	10) (Fig- 1050		V _{CC} – 50	mV
I _{IH}	Input HIGH Current (VTx/VTx Open)	-150		150	μA
۱ _{IL}	Input LOW Current (VTx/VTx Open)	-150		150	μA
CONTRO	DL INPUT (Reset pin)				
V _{IH}	Input HIGH Voltage for Control Pin	V _{CC} – 200		V _{CC}	mV
V _{IL}	Input LOW Voltage for Control Pin	GND		200	mV
I _{IH}	Input HIGH Current	-150	1	150	μA
IIL	Input LOW Current	-150	1	150	μA
TERMINA	ATION RESISTORS				
R _{TIN}	Internal Input Termination Resistor	45	50	55	Ω
	Internal Output Termination Resistor	45	50	55	Ω

operating temperature range. Functional operation of the device exceeding these conditions is not implied. Device specification limit values are applied individually under normal operating conditions and not valid simultaneously.

5. Input and output parameters vary 1:1 with V_{CC} .

6. CML outputs loaded with 50– Ω to V_{CC} for proper operation.

7. Vth, V_{IH} , $V_{IL_{m}}$ and V_{ISE} parameters must be complied with simultaneously. 8. Vth is applied to the complementary input when operating in single–ended mode.

VII IS applied to the complementary input when operating in single-ended mode.
 V_{IHD}, V_{ILD}, V_{ID} and V_{CMR} parameters must be complied with simultaneously.
 V_{CMR} min varies 1:1 with GND, V_{CMR} max varies 1:1 with V_{CC}. The V_{CMR} range is referenced to the most positive side of the differential input signal.

Symbol	Characteristic			Тур	Max	Unit
f _{MAX}	Maximum Input Clock Frequency		10	11		GHz
V _{OUTPP}	Output Voltage Amplitude (@ $V_{INPPmin}$) $f_{in} \le 10 \text{ GHz}$ (Note 12) (Figure 3)	Output Voltage Amplitude (@ $V_{INPPmin}$) $f_{in} \le 10 \text{ GHz}$ (Note 12) (Figure 3)		400		mV
t _{PLH} , t _{PHL}	Propagation Delay to Differential Outputs, @ 1 GHz, measured at differential crosspoint	CLK/CLK to Q, Q R to Q, Q	150 500	200 600	350 700	ps
t _{PLH} TC	Propagation Delay Temperature Coefficient			50		∆fs/°C
t _{skew}	Duty Cycle Skew (Note 13) Device – Device skew (tpdmax – tpdmin)				20 50	ps
t _{RR}	Reset Recovery (See Figure 16)		550	135		ps
t _{PW}	Minimum Pulse Width R		500	200		ps
t _{DC}	Output Clock Duty Cycle (Reference Duty Cycle = 50%) $f_{in} \le 10 \text{ GHz}$		45	50	55	%
ΦN	Phase Noise, f _c = 1 GHz 10 kHz 100 kHz 1 MHz 10 MHz 20 MHz 40 MHz			-144 -147 -152 -152 -152 -153		dBc
$t_{j\phi N}$	Integrated Phase Jitter (Figure x) $f_c = 1 \text{ GHz}$, 12 kHz – 20 MHz Offset			35		fs
t _{JITTER}	RJ – Output Random Jitter (Note 14) $f_{in} \leq 10.0 \text{ GHz}$			0.2	0.8	ps RMS
V _{INPP}	Input Voltage Swing (Differential Configuration) (Figure 11) (Note 15)		200		1200	mV
t _r , t _f	Output Rise/Fall Times @ 1 GHz (20% – 80%), Q, Q		20	35	60	ps

Table 6. AC CHARACTERISTICS V_{CC} = 1.71 V to 2.625 V; GND = 0 V; T_A = -40°C to 85°C (Note 11)
--

NOTE: Device will meet the specifications after thermal equilibrium has been established when mounted in a test socket or printed circuit board with maintained transverse airflow greater than 500 lfpm. Electrical parameters are guaranteed only over the declared operating temperature range. Functional operation of the device exceeding these conditions is not implied. Device specification limit values are applied individually under normal operating conditions and not valid simultaneously.

Measured using a 1 GHz, V_{INPP}min, 50% duty-cycle clock source. All output loading with external 50 Ω to V_{CC}. Input edge rates 40 ps (20% – 80%).

12. Output voltage swing is a single-ended measurement operating in differential mode.

13. Duty cycle skew is defined only for differential operation when the delays are measured from cross-point of the inputs to the cross-point of the outputs. Duty cycle skew is measured between differential outputs using the deviations of the sum of Tpw- and Tpw+ @ 1 GHz. Skew is measured between outputs under identical transitions and conditions.

14. Additive RMS jitter with 50% duty cycle clock signal.

15. Input voltage swing is a single-ended measurement operating in differential mode.

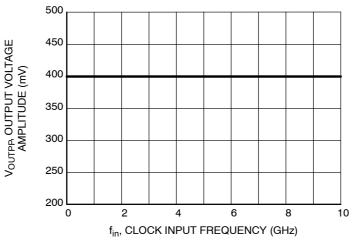
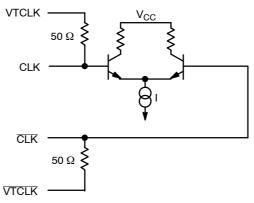
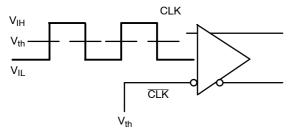
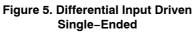


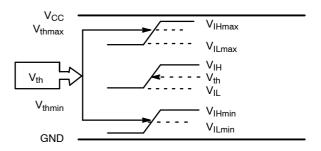
Figure 3. Output Voltage Amplitude (V_{OUTPP}) vs. Input Frequency (f_{in}) at Ambient Temperature (Typical)



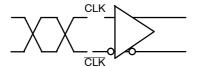




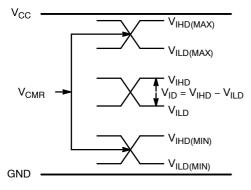




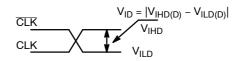




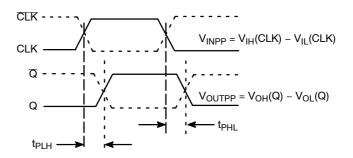




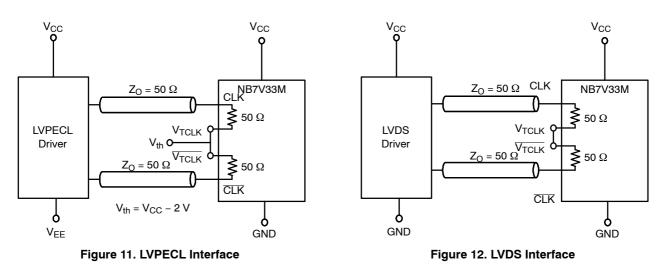


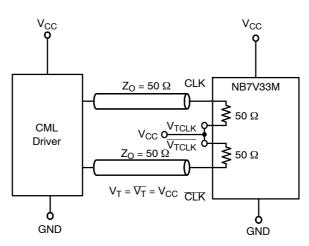


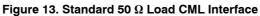


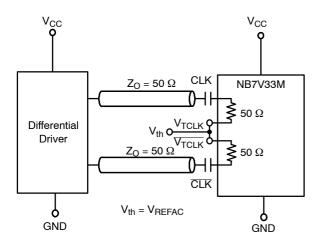


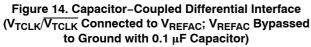


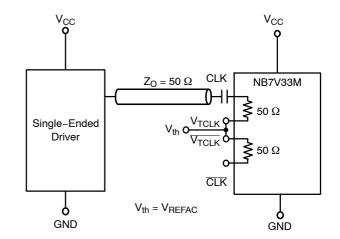


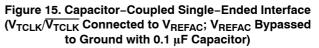












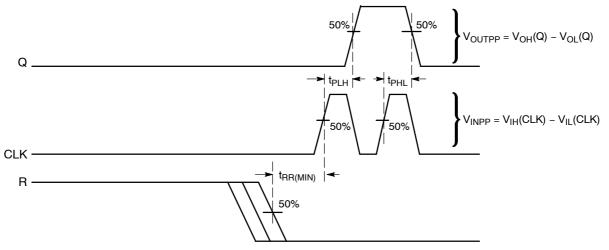


Figure 16. AC Reference Measurement (Timing Diagram)

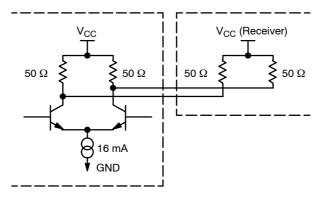


Figure 17. Typical CML Output Structure and Termination

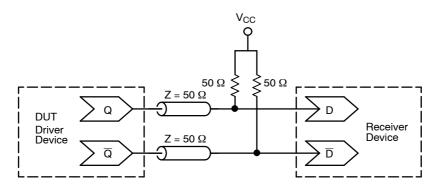


Figure 18. Typical Termination for CML Output Driver and Device Evaluation

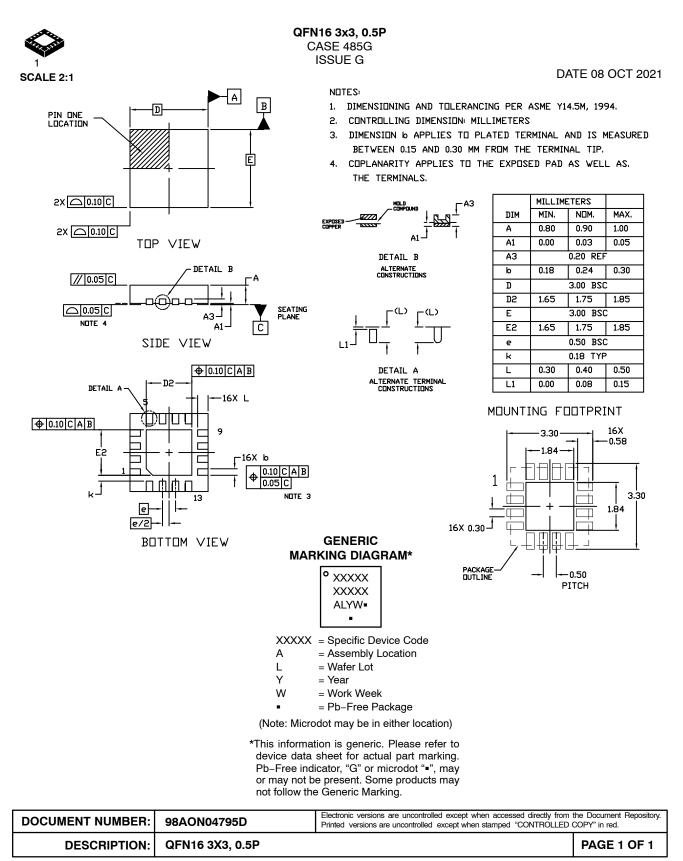
DEVICE ORDERING INFORMATION1

Device	Package	Shipping [†]
NB7V33MMNG	QFN-16 (Pb-Free)	123 Units / Rail
NB7V33MMNHTBG	QFN-16 (Pb-Free)	100 / Tape & Reel
NB7V33MMNTXG	QFN-16 (Pb-Free)	3000 / Tape & Reel

+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

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